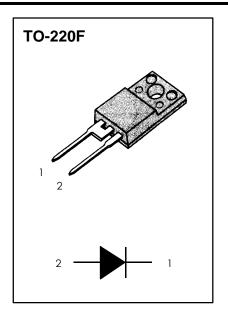
## **FEATURES**

- \* Ultrafast with Soft Recovery (Trr < 40ns)
- \* Low Forward Voltage (V<sub>F</sub>=0.98V at I<sub>F</sub>=30A)

# **APPLICATIONS**

- \* Power Switching Circuits
- \* Output rectifiers
- \* Freewheeling Diodes
- \* Switching Mode Power Supply



# **MAXIMUM RATINGS**

Rating	Symbol	mbol Value	
Peak Repetitive Reverse Voltage	$V_{RRM}$	200	٧
Average Rectified Forward Current, T <sub>C</sub> =100 °C	I <sub>F(AV)</sub>	30	А
Non-repetitive Peak Surge Current	I <sub>FSM</sub>	300	А
(Half-wave, Single Phase, 60Hz)			
Operating Junction and Storage Temperature	$T_J, T_STG$	-65 ~ 150	°C

# THERMAL CHARACTERISTICS

Thermal Resistance - Junction to Case	$R_{\theta JC}$	1.7	°C/W
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# **ELECTRICAL CHARACTERISTICS**

Characteristics	Symbol	Min	Тур	Max	Units
Maximum Instantaneous Forward Voltage (1)	$V_{F}$				
(I <sub>F</sub> = 30A, T <sub>C</sub> = 100 °C)		-	-	1.0	V
$(I_F = 30A, T_C = 25  ^{\circ}C)$		-	-	1.2	
Maximum Instantaneous Reverse Current (1)	I <sub>R</sub>				
(Rated DC Voltage, T <sub>C</sub> = 100 °C)		-	-	300	μΑ
(Rated DC Voltage, T <sub>C</sub> = 25 °C)		-	-	30	
Maximum Reverse Recovery Time	trr	-	-	40	ns
$(I_F = 30A, di/dt = -200A/\mu s)$	Irr	-	-	4.0	Α
	Qrr	-	-	80	nQ
Avalanche Energy	$W_{AVL}$	0.5	-	-	mJ

(1) Pulse Test : Pulse Width =  $300\mu s$ , Duty Cycle  $\leq 2.0\%$ 

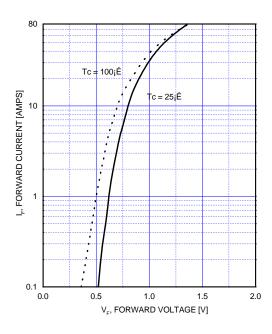


Fig.1 Typical Forward Voltage Drop vs. Forward Current

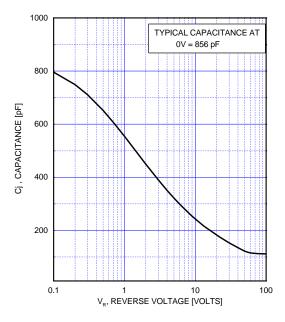


Fig.3 Typical Capacitance

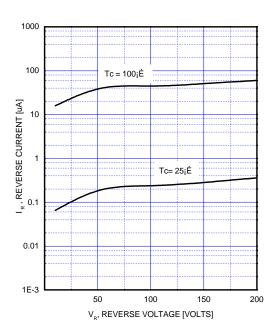


Fig.2 Reverse Voltage vs. Reverse Current

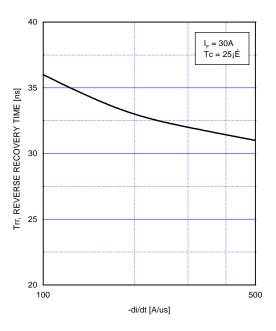
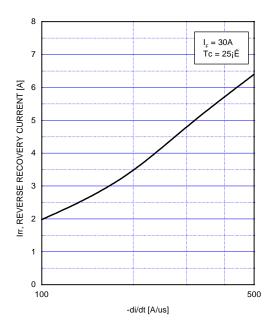


Fig.4 Typical Reverse Recovery Time vs. di/dt





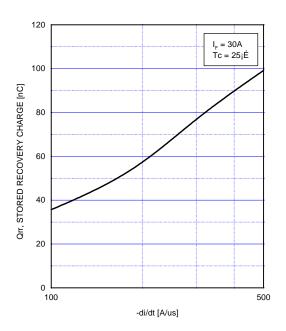
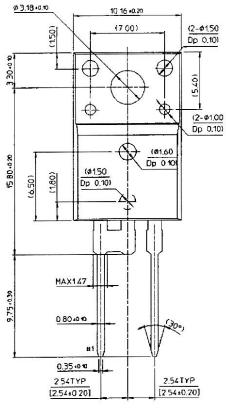
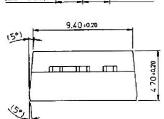


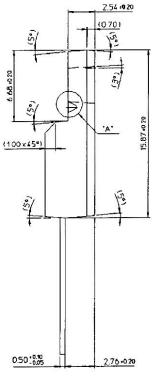
Fig.5 Typical Reverse Recovery Current vs. di/dt

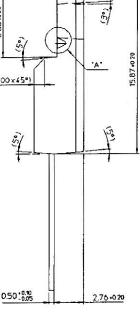
Fig.6 Typical Stored Charge vs. di/dt

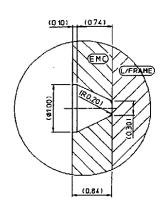
## **PACKAGE DIMENSION**











"A")

(DETAIL

Unit: mm

NOTE

1. THESE DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION

2. ( ) IS REFERENCE

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FACT Quiet Series  $^{\text{TM}}$  Quiet Series  $^{\text{TM}}$  SuperSOT  $^{\text{TM}}$ -3 SuperSOT  $^{\text{TM}}$ -6 GTO  $^{\text{TM}}$  SuperSOT  $^{\text{TM}}$ -8 TinyLogic  $^{\text{TM}}$ 

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